Silicon NPN Triple Diffused

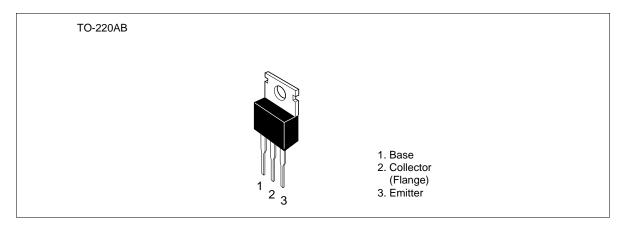
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ADE-208-906 (Z) 1st. Edition Sep. 2000

Application

Low frequency power amplifier complementary pair with 2SB859

Outline



Absolute Maximum Ratings (Ta = 25°C)

Symbol	Ratings	Unit
V _{CBO}	100	V
V _{CEO}	80	V
V _{EBO}	5	V
Ι _c	4	А
I _{C(peak)}	8	А
Pc*1	40	W
Tj	150	°C
Tstg	-45 to +150	°C
	V _{CBO} V _{CEO} V _{EBO} I _C I _{C(peak)} P _C * ¹ Tj	V_{CBO} 100 V_{CEO} 80 V_{EBO} 5 I_c 4 $I_{C(peak)}$ 8 P_c^{*1} 40 Tj 150

Note: 1. Value at $T_c = 25^{\circ}C$.



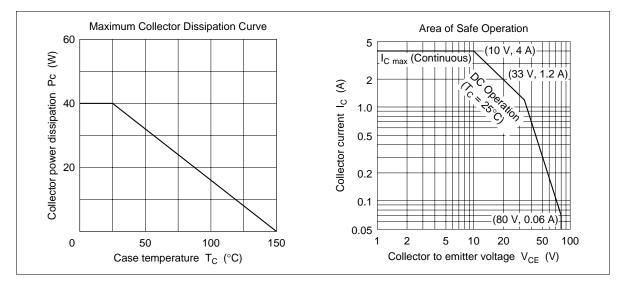
Electrical Characteristics (Ta = 25° C)

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to emitter breakdown voltage	$V_{\rm (BR)CEO}$	80	_	_	V	$I_c = 50 \text{ mA}, \text{ R}_{\text{BE}} = \infty$
Emitter to base breakdown voltage	$V_{(\text{BR})\text{EBO}}$	5	_	_	V	$I_{\rm E} = 10 \ \mu A, \ I_{\rm C} = 0$
Collector cutoff current	I _{CBO}	—	—	0.1	mA	$V_{CB} = 80 \text{ V}, \text{ I}_{E} = 0$
DC current transfer ratio	$h_{\rm FE1}^{*1}$	60	—	200		$V_{ce} = 5 \text{ V}, \text{ I}_{c} = 1 \text{ A}^{*2}$
	\mathbf{h}_{FE2}	35	—	—		$V_{ce} = 5 \text{ V}, I_c = 0.1 \text{ A}^{*2}$
Base to emitter voltage	V_{BE}	—	—	1.5	V	$V_{ce} = 5 \text{ V}, \text{ I}_{c} = 1 \text{ A}^{*2}$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	_	_	2	V	$I_{\rm c} = 2$ A, $I_{\rm B} = 0.2$ A* ²
Gain bandwidth product	f _T	—	10	—	MHz	$V_{ce} = 5 \text{ V}, \text{ I}_{c} = 0.5 \text{ A}^{*2}$
Collector output capacitance	Cob		40	_	рF	$V_{_{CB}} = 20 \text{ V}, \text{ I}_{_{E}} = 0, \text{ f} = 1 \text{ MHz}$

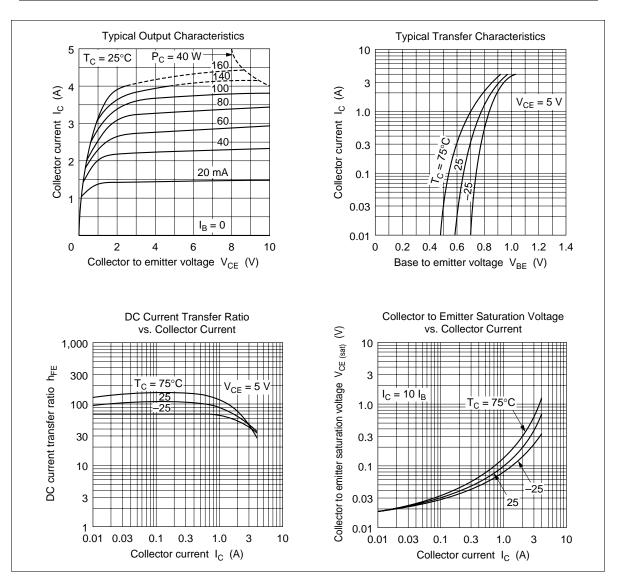
Notes: 1. The 2SD1135 is grouped by h_{FE1} as follows.

2. Pulse test.

В	С
60 to 120	100 to 200

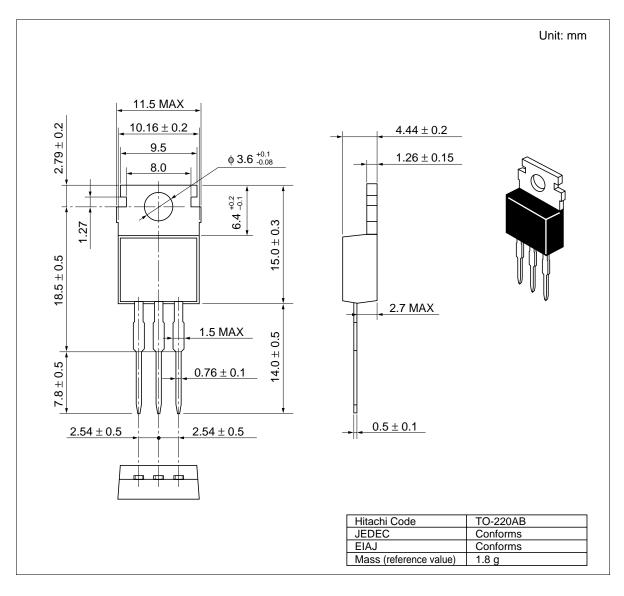


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Package Dimensions



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